

Fabrication and assembly of thermoplastic microfluidics; a review

Amid Shakeri¹, Shadman Khan², Noor Abu Jarad², Tohid F Didar^{1,2,*}

¹ Department of Mechanical Engineering, McMaster University, 1280 Main Street West, Hamilton, ON L8S 4L7, Canada.

² School of Biomedical Engineering, McMaster University, 1280 Main Street West, Hamilton, ON L8S 4L8, Canada.

* To whom correspondence should be addressed. E-mail: didar@mcmaster.ca

Abstract

Various fields within biomedical engineering have been afforded rapid scientific advancement through the incorporation of microfluidics. As literature surrounding biological systems become more comprehensive and many microfluidic platforms show potential for commercialization, the development of representative fluidic systems has become more intricate. This has brought increased scrutiny towards the material properties of microfluidic substrates. Thermoplastics have been highlighted as a promising material, given their material adaptability and commercial compatibility. This review provides a comprehensive discussion surrounding recent developments pertaining to thermoplastic microfluidic device fabrication. Existing and emerging approaches related to both microchannel fabrication and device assembly are highlighted, with consideration towards how specific approaches induce physical and/or chemical properties that are optimally suited for relevant real-world applications.

Keywords: Microfluidics, thermoplastic, microchannel fabrication, bonding

1 Introduction

Since their inception three decades ago, microfluidic platforms have repeatedly redefined state-of-the-art approaches to fluidic automation, biochemical assays, high-throughput clinical screening, and a plethora of other areas¹⁻⁶. Glass and polydimethylsiloxane (PDMS) have represented two key materials of choice in the microfluidics space, due to their physical and chemical versatility. The use of both these materials in microfluidics has been comprehensively discussed in our recent reviews^{7,8}. However, the widespread implementation of devices composed of glass and PDMS has been severely limited by their costly and labour-intensive fabrication process, poor scalability, and high variability between devices. From a materials perspective, PDMS microfluidic platforms have demonstrated poor surface treatment stability and high susceptibility towards biomolecule adsorption, making them impractical for most biomedical applications⁹. Furthermore, leaching of uncrosslinked oligomers of PDMS could be problematic for cell culture applications¹⁰. On a more macro-scale, these devices often malfunction under high-pressure conditions, making many post-fabrication processing strategies unfeasible. Recent research efforts have thus been directed towards the material optimization of microfluidic devices. To this end, thermoplastic microfluidic platforms have garnered significant interest, given their excellent material properties and low device cost, relative to their glass and PDMS device counterparts. Materials such as poly(methyl methacrylate) (PMMA), cyclic Olefin polymer (COP), cyclic olefin copolymer (COC), polystyrene (PS), polycarbonate (PC), polyethylene glycol (PEG) and polyester terephthalate (PETE) are considered cost-effective thermoplastic polymers for microfluidic fabrications, providing biocompatibility, gas permeability and good optical properties¹¹⁻¹⁴.

There are two steps involved in the development of thermoplastic microfluidic platforms: device fabrication and channel functionalization – the latter of which we have extensively reviewed in a recent review paper ¹¹. In this review, we provide a comprehensive overview of recent developments in the thermoplastic device fabrication space. More specifically, we first provide a thorough account of the instrumentation and approaches that can be engaged to form microchannel networks within thermoplastic polymer substrates. We subsequently detail the different approaches for bonding these microchannels, with consideration towards channel functionalization, which often occurs in parallel.

Given the active nature of thermoplastic microfluidic research, legacy approaches are constantly being modified to improve performance and commercial potential. This, paired with emerging device fabrication strategies, provides a research landscape in need of such an up-to-date source for thermoplastic device fabrication. As such, this review pairs foundational studies with recent works and emerging approaches to provide new insights into the direction of this field.

2 Forming the microchannel geometry

2.1 Hot embossing

Hot embossing is a common technique for the mass production of thermoplastic polymers with relatively low costs ^{15–20}. In hot embossing, the polymer plate is heated above the glass transition temperature while it is pressed against a master mold with channel protrusions by a hydraulic press to form the microfluidic arrays as cavities in the polymer. The thermoplastic polymer plates used in hot embossing could be fabricated by injection molding ^{21,22}. Before performing the hot embossing process, the polymer plate may be annealed to reduce residual stress ²¹. Depending on

the polymer type, thickness, polymer chain orientation, and the experimental design, the applied pressure and temperature vary. After the process, which takes a few minutes (*e.g.* 2-20 min), the pressure is usually maintained as the samples cool down to enhance the uniformity^{18,23}.

Hot embossing was done at 150 °C on a COC pellet for 6 min under 1.38 MPa followed by maintaining the polymer for 10 min at 25 °C under the same pressure²³. Also, PC microchannels were prepared via compressing PC plates on a photolithographic patterned silicon mold at 155 °C with 1.2 MPa for 2 min followed by 5 min at 50°C while the pressure was kept constant¹⁵. Young *et al.* hot embossed PS substrates against an epoxy mold at 125 °C under the 900 kgf pressure for 15 min¹⁹. COP/COC have shown superior performance compared to PMMA chips fabricated via hot embossing, with higher signal to noise ratios and higher electrophoresis efficiencies due to their low impurity levels and high glass transition temperatures²⁴. The embossing reference temperature (143°C) for COC/COP microchannels is determined by the viscoelastic property of these polymers, while other processing parameters such as the temperature, time, and pressure in the cooling and demolding stages are determined by the Taguchi method. A COP microfluidic channel is said to have a high repeatability and low substrate deformation when it exhibits the following optimized parameters: reference temperature 143 °C, holding time 2 min, pressure 1.6 MPa, and demolding temperature 80 °C²⁵.

Hot embossing is also a popular method to create microchannels out of thermoplastic elastomers (TPEs). The produced microchannels are transparent, flexible, and biocompatible²⁶⁻²⁸. Schneider *et al.* used this technique to make PC/TPE-hybrid microfluidic channels using epoxy-based master molds (**Figure 1 a**)²⁸. Hot embossing can be integrated with roll-to-roll printing, where a rotating embossing cylinder is used to transfer the microchannel features of the cylinder into a heated polymer web continuously fed into the system²⁹. In order to create the embossing cylinder with

the desired features, an embossing shim (thin strip of material on the cylinder) can be fabricated from a flexible steel using wet-etching and then laser welded to the cylindrical sleeve ²⁹. As roll-to-roll hot embossing allows for continuous heating and forming the substrate, it is considered a faster approach compared to normal hot embossing or micro-injection molding techniques. Runge *et al.* presented a different type of hot embossing process where a PC thermoplastic polymer was pressed against a master mold via a tool capable of generating ultrasonic vibrations (sonotrode) **(Figure 1 b)** ³⁰. The induced friction as a result of the vibrations could rapidly increase the temperature of the substrate above the glass transition temperature and form the desired patterns on the sheet. The process could be completed in a few seconds which enable rapid replicating of thermoplastic microfluidics. However, the size of the channel that is possible to form by this method is typically limited to 50 μm to 1 mm in depth and 100 μm to 3 mm in width.

2.2 Injection molding

Injection molding is another method frequently used to create microchannels in thermoplastics ^{22,31,32}. In this process, the thermoplastic polymer granules are melted (plasticization step) and injected into the mold cavity. The molten polymer is then solidified as the temperature decreases below the glass transition temperature (cooling stage) and finally ejected from the mold. The molding process is done under constant pressure to compensate for the shrinkage of the polymer during solidification. The process cycle takes seconds to a few minutes ³¹. In addition to polymeric material properties, several process parameters such as melt temperature and mold temperature, speed of filling and packing time, as well as packing and holding pressures attribute to the efficiency of the process and quality of the final product ³³. Ogorodnyk *et al.* have conducted a comprehensive review on the implementation of artificial intelligence (AI) methods for the monitoring and controlling of the parameters involved in injection molding ³⁴. The cooling stage

is the most time-consuming part of the injection molding. In order to accelerate the process, rapid heating and cooling technologies by means of conformal cooling or variotherm system have been introduced. Conformal cooling could be conducted via accommodating cooling channels in the mold and conforming them to the shape of the mold cavity. The cooling channels can be made in different designs such as spiral conformal cooling channels ³⁵, milled grooved square shape conformal cooling channels ³⁶, and longitudinal conformal cooling channels ³⁷. Conformal cooling significantly reduces the cooling time in a more uniform and consistent way by increasing the heat transfer efficiency, thereby enhancing the quality of the formed thermoplastic polymer. The channels in conformal cooling could also be used for heating the injected thermoplastic in order to prevent it from early solidification during the injection process as premature solidification can lead to defect formation in the product. In variotherm injection molding, the mold temperature is dynamically controlled according to each stage of the process. Before the injection, the temperature is raised to the glass transition temperature of the thermoplastic polymer. Then, the temperature is increased above the glass transition and kept constant during the mold filling step. Afterwards, the mold is rapidly cooled for the solidification of the polymer and the ejection step. Controlling the temperature could be performed by electromagnetic induction heating, which can heat up the mold from 110 °C to 200 °C in only 4 seconds ³⁸. By using a proper coolant, the cooling time also takes only 20 seconds to reach 110 °C again ³⁸. Another way to heat the mold is to use steam at a temperature of 180 °C, which can increase the temperature in injection molding from 30 °C to 140 °C in 20 seconds ³⁹. Water can be used in this approach to cool down the mold and solidify the injected polymer. CO₂ lasers have also been used to heat the injected resin ⁴⁰.

Ma *et al.* have thoroughly investigated the injection molding of PMMA-based microfluidic devices using a horizontal single screw injection molding machine capable of performing each injection

cycle in 45 s (**Figure 1 c**)⁴¹. They set the injection pressure at 120 MPa and the speed ranged between 200 mm/s to 400 mm/s. The injection was performed at 60 °C using an oil mold temperature controller. In another study, Kim *et al.* applied 5.5 MPa injection pressure and clamping force of 130 tons to create PS microfluidic channels at 220 °C in 15 s, and used the device for single cell analysis⁴². Using the same injection molding parameters, Ko *et al.* fabricated an open circular microfluidic chip made of PS for ocular angiogenesis applications⁴³. Injection molding was also adopted in Viehrig *et al.*'s work to form nanocones in COC through a nickel master mold (**Figure 1 d**)⁴⁴. The device was employed for SERS sensing applications.

In general, hot embossing and injection molding are more appropriate for medium-cost mass production through replication methods and can be implemented for the manufacturing of complex channel designs. Moreover, the quality of surface finish in these methods is superior compared to other methods such as laser machining, micro-milling, and 3D printing. Injection molding is a very rapid method allowing for large-volume production. Hot embossing, in comparison, has an average production rate, but it requires less expensive tools and infrastructure. The primary disadvantage of injection molding pertains to limitations when fabricating microchannels with large footprints, whereas in hot embossing, large area machining is possible. It is worth mentioning that the polarity of the thermoplastic polymers affects their meltability. High polar polymers are very difficult to melt in their pure form due to their strong interchain forces⁴⁵. Moreover, polar thermoplastics are not quite permeable to oxygen and carbon dioxide which could be problematic in cell culture applications. Polar thermoplastics also have poor water barrier properties, which can lead to changes in local concentrations when implemented within applications that use water-based buffers and liquids. A comparison between the polarities of different thermoplastic polymers can be found elsewhere⁴⁶.

2.3 Master mold fabrication

The master molds used for the fabrication of thermoplastic polymers in both hot embossing and injection molding are usually fabricated by photolithography^{15,16,21,47}. Nevertheless, several other fabrication methods such as e-beam writing, electroforming, micro-milling, and electro discharge machining, laser machining, ion machining, additive manufacturing, and ultrasonic machining are applicable for master mold production³¹, as long as the master mold can withstand the high pressures and temperatures used in the hot embossing or micro-injection techniques. High-precision nickel molds^{17,18,22,48}, micro-milled aluminum⁴²⁻⁴⁴, and Zr-based bulk metallic glass mold³² are other master molds used in literature. For instance, a negative master mold was produced in Müller *et al.*'s work via electroplating Ni on a 3D printed master mold⁴⁸. The negative master mold was then used for creating COC microchannels through injection molding. Hupert *et al.* used a high-precision micro-milling machine, which had positional and repetition accuracy of $\pm 1 \mu\text{m}$, a laser measuring system and an optical microscope to create microstructures on a brass plate to be employed as a mold for the hot embossing of PMMA substrates⁴⁹. Micro-milling of brass templates has also been performed in other studies to create master molds for hot embossing microchannels in PMMA, PC, and COC substrates^{50,51}. PDMS has also been utilized as a master mold for the fabrication of thermoplastic polymers (**Figure 1 e**)²³. In Chantiwas *et al.*'s study, PDMS master molds were prepared by casting PDMS at a base: curing agent ratio of 10:1 (w:w) in PMMA replicated micro/nano channels⁵⁰. After curing the PDMS and peeling it off, it was used to hot emboss other PMMA substrates under a pressure of 0.16 MPa at 155 °C for 30 minutes. Schneider *et al.* generated a negative PDMS mold by casting PDMS on an SU-8 coated silicon wafer. They used this negative PDMS mold to produce an epoxy-based master mold for creating microfluidic channels made of TPE/PC using hot embossing approach²⁸.

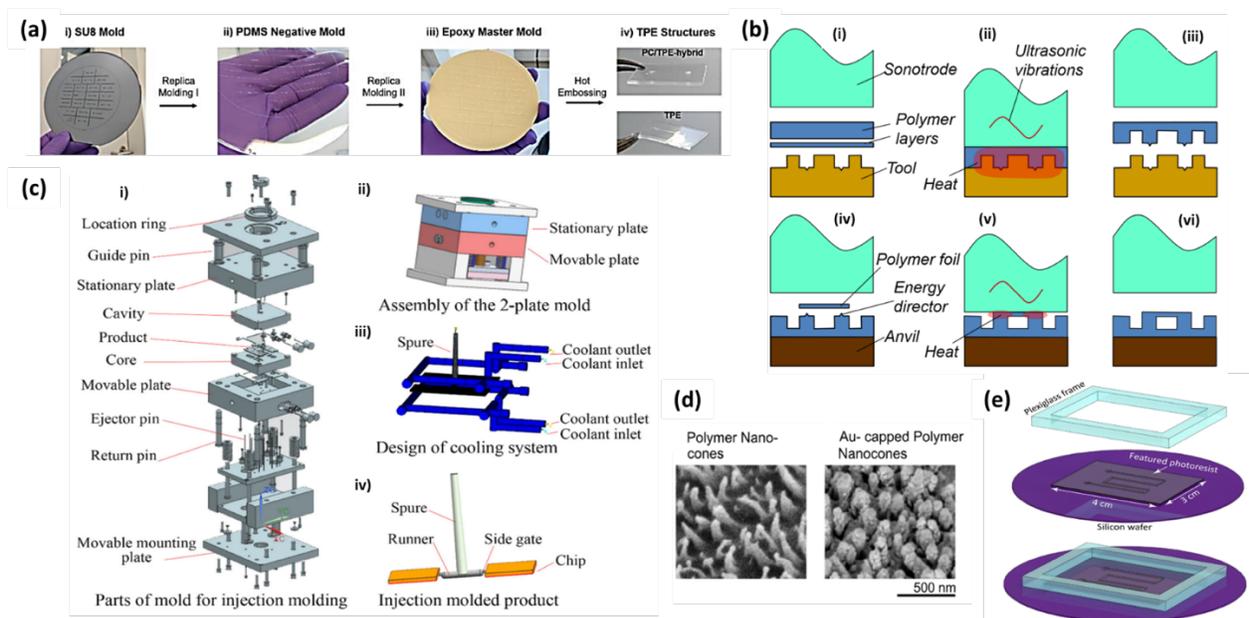


Figure 1. (a) Fabrication process of PC/TPE-hybrid microchannels via hot embossing method. Reprinted from Ref. ²⁸ with permission from MDPI. (b) (i-iii) Incorporation of ultrasonic vibration in hot embossing process to form PC microchannels (iv-vi) ultrasonic welding of PC layers. Reprinted from Ref. ³⁰ with permission from Springer. (c) Injection mold design for fabrication of PMMA microfluidic devices. Reprinted from Ref. ⁴¹ with permission from Springer. (d) SEM images of nanocones made of COC through injection molding techniques. Reprinted from Ref. ⁴⁴ with permission from ACS. (e) Silicon mold with photoresist patterns and plexiglass frame. The setup was used to cast PDMS master molds for hot embossing COC and creating microchannels. Reprinted from Ref. ²³ with permission from Elsevier.

2.4 Laser ablation

Another technique used for fabrication of the thermoplastic polymers with microfluidic channel cavities is laser ablation, which is applicable to many polymers such as PC, COC/COP, PMMA, PS, nitrocellulose, PET, PETE, and Teflon ⁵²⁻⁶¹. In this method, short laser pulses in the ultraviolet (UV) region (~200 nm wavelength) breaks the polymer chains. The decomposed polymer fragments such as CO₂ and CO gas and polymer molecules are subsequently ejected due to the induced shock waves leaving photo-ablated cavities ⁵⁵. Patterning the microchannel arrays can be

conducted by using photo masks in the process resulting in straight vertical walls without any significant thermal damage. It should be noted that laser ablation in the UV wavelength cannot be used for thermoplastic polymers such as COC/COP due to their low UV absorption. Thus, infrared lasers such as CO₂ or Nd:YAG laser systems should be adopted for microchannel formation. Namely, Liu *et al.* fabricated a COP-based microfluidic channel *via* CO₂ laser ablation using pulse mode at a maximum frequency of 1kHz, whereas a Gaussian-like profile was left on the surface of the COP plate as the COP melted, decomposed, and evaporated. They concluded that the main parameters affecting the profile of the microchannel included the power and scan speed of the laser, as well as the focusing accuracy of the laser and the mechanical transmission system⁵⁹. CO₂ laser ablation was also adopted to pattern PC and polylactic acid (PLA) sheets with the desired micro-features^{52,62}, and to create microchannel arrays in PET foils⁶³. Laser ablation is also possible via desktop CO₂-free laser cutters to create the sheets and membranes with the desired geometries⁶¹. Commercially available laser systems are flexible approaches for rapid redesign of channel geometries and are usually cheaper than some other techniques such as injection molding, which requires metal molds or photolithography – a process that needs to be conducted in a cleanroom. The main drawbacks of laser ablation technique are the poor quality of the surface finish and its incapability for the fabrication of complex microchannel designs⁶⁴. Further, the cut profile in conventional laser cutters is only limited to Gaussian-shaped profile or through cuts (**Figure 2 a**)⁶⁵. Formation of bulge along the scan route is another common problem associated with laser cutting technique⁶⁶. Chai *et al.* showed that high thermal resistant thermoplastic polymers such as polyformaldehyde (POM) can be CO₂ laser cut without formation of bulges and carbide residue, and the channel depth and width are easily adjustable by changing the scan speed

and laser energy (**Figure 2 b**)⁶⁷. Covering PMMA substrates by photoresist or PDMS is another way to tackle the bulge formation⁶⁸.

2.5 Other methods

Milling^{69–74}, and UV curing (specially for PEG)^{75–78} are other methods to form the microchannels in thermoplastic polymers. Micro-milling of thermoplastic polymers can be incorporated for the fabrication of complex microchannel profiles with small or large surface areas. The production rate of this process is quite rapid, and it allows for instant changes in the channel design in the production line. Moreover, unlike laser ablation, it can create microchannels with nearly rectangular cross-sections. Nevertheless, the quality of the surface finish is not good in this process. In order to decrease the surface roughness and regain transparency after milling COC substrates, Bruijns *et al.* exposed the COC substrates to cyclohexane vapor at 60 °C for 1 min⁷³. UV curing of low molecular weight polyethylene glycol (PEG) monomers such as PEG dimethacrylate and PEG diacrylate (PEG-DA) on a silicon mold with the microchannels arrays or pillars can be performed to fabricate PEG microchannels and porous PEG membranes, respectively (**Figure 2 c**)⁷⁷. During casting, a PET layer modified with urethane groups could be placed on top as the supporting layer to adhere to the acrylate-containing PEG monomers. As the supporting layer, it is also possible to use glass slides treated with phosphoric acrylate or acrylic acid dissolved in propylene glycol monomethyl ether acetate, to bind to PEG⁷⁷. In another study, Liu *et al.* first made an enclosed mold comprising a bottom silicon layer with the channel's array, middle PDMS spacers, and a top glass slide⁷⁵. Afterwards, PEG-functionalized monomer solution containing 85% PEG-DA, 12% poly(ethylene glycol) methyl ether methacrylate (PEG-MEMA), 3% methyl methacrylate, and 2,2'-dimethoxy-2-phenylacetophenone (DMPA) was injected onto the mold and cured for 16 s under UV. Tian *et al.* also UV cured PEG-DA on a PDMS mold using 1%

photoinitiator Irgacure 2959 to form the microfluidic design ⁷⁸. UV lithography has also been used to create micro-geometries in PMMA substrates ^{79,80}. This process involves UV exposure of the PMMA substrate with a photoresist through a mask and development of the photoresist, coating a thick layer of X-ray absorber to the exposed areas to create an X-ray mask, emitting X-ray to form the desired channels, and finally removing the X-ray mask from the substrate.

Chandrasekaran *et al.* presented a new thermal scribing method to rapidly prototype thermoplastic microfluidic devices ⁸¹. In this technique, a heating pen was incorporated into a commercially available craft cutter machine. The induced heat in the pen could locally raise the temperature of the thermoplastic polymer above the glass transition temperature and precisely pattern the layer with the desired geometry.

Nowadays, additive manufacturing of thermoplastic polymers has produced great interest in microfluidics. 3D printing of thermoplastic polymers (such as ABS, PLA, PS, PC, PMMA, and PET) via different techniques including fused deposition modelling and inkjet printing offers several advantages such as simplicity, low cost, usually high speed, more versatility and freedom in complex channels design, and elimination of the need for bonding steps in some cases ⁸²⁻⁸⁷. However, the resolution of 3D printed microchannels, mechanical properties, as well as the optical quality of the surface finish is not as good as the aforementioned techniques. Additive manufacturing of thermoplastic polymers are deeply discussed elsewhere ^{88,89}. Typically, additive manufacturing as well as micro-milling and laser ablation are more suitable for fast prototyping of thermoplastic microfluidics.

Another interesting way to fabricate microfluidic features is via the use of dry films, which were originally developed for printed circuit boards ⁹⁰⁻⁹³. This technique is usually compared with

photolithography – used for fabrication of SU-8 layers, or soft lithography, which is used to prepare molds for casting polymers such as PDMS. While photolithography is an expensive method that needs cleanroom facilities and expert technicians, the fabrication of microchannels via dry films is a simple cleanroom-free approach which can provide comparable resolution and precision to SU-8 photolithography. Dry films resists (DFR) in different series such as Ordyl, SUEX, and ADEX, TMMF S, as well as SU-8 based DFR are commercially available in different thicknesses. DFRs can be laminated on a variety of different thermoplastic substrates or other types of materials via a simple office laminator. Subsequently, the layer is exposed to UV light through a photomask with the desired features and baked on a hotplate for a short period of time. Afterwards, the layer is immersed in a developer solution to form the cavities. The process of lamination and UV treatment can be performed multiple times to acquire microchannels with different heights or multiple layers (3D microfluidics). The microchannels can become hydrophilic through plasma treatment or polyvinyl alcohol if needed ⁹³. DFRs have also been utilized as a sealing layer in microfluidics made by injection molding. Moreover, researchers have used DFRs in fabrication of molds for hot embossing and PDMS casting processes ^{94–96}.

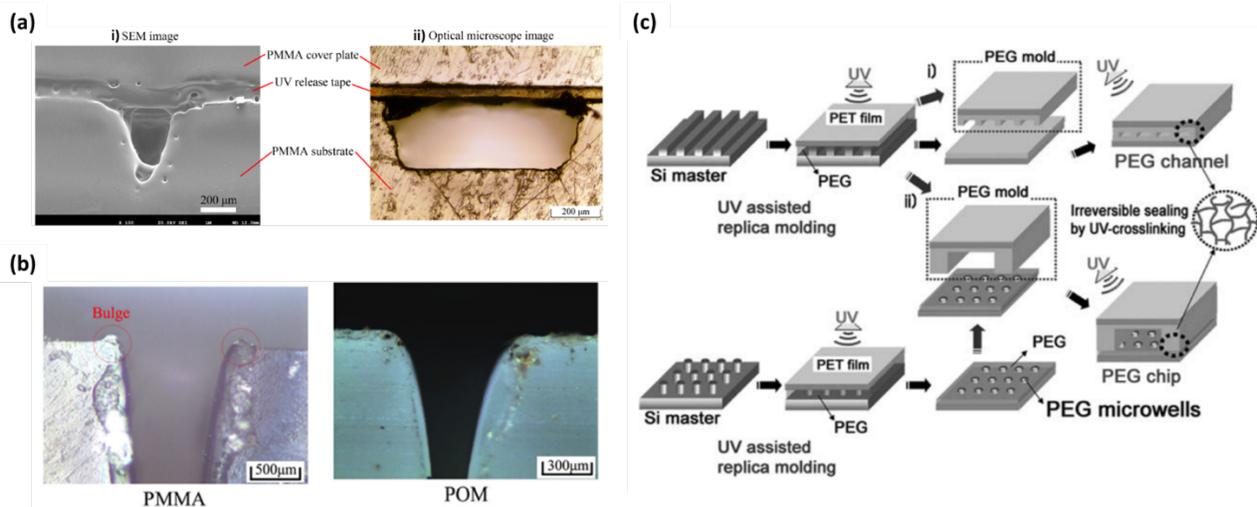


Figure 2. (a) (i) SEM image of PMMA microchannel's cross-section fabricated by CO₂ laser ablation (ii) Optical image of PMMA microchannel's cross-sectional fabricated by micro-milling technique. Reprinted from Ref. ⁶⁵ with permission from Springer. **(b)** Optical images of PMMA and POM microchannels' cross-sections fabricated by laser ablation. Reprinted from Ref. ⁶⁷ with permission from Springer. **(c)** Fabrication of PEG layers containing microchannels or microwells features and bonding to flat PET or PEG layers through UV polymerization technique. Reprinted from Ref. ⁷⁷ with permission from Royal Society of Chemistry.

3 Bonding

Unlike PDMS and glass, where surface hydroxylation via oxygen plasma treatment, ultraviolet-ozone (UVO) treatment, or corona discharge method is the main bonding technique, use of such systems for thermoplastic polymers usually lead to very weak bonding. Moreover, exposure of thermoplastic to UV, ozone or oxygen plasma could produce cytotoxic by-products such as hydrogen peroxide which is troublesome for many biomedical applications and cell studies ⁹⁷. The most commonly reported techniques to irreversibly bond thermoplastic polymers together and form enclosed microfluidic devices include thermal fusion bonding ^{15,16,18–21,53,69,98}, solvent bonding ^{17,22,23,29,54,99}, and chemical bonding ^{100,101}.

3.1 Thermal fusion bonding

In thermal fusion bonding, the polymeric layers are heated above their glass transition temperatures, while the layers are pressed together using a hydraulic press or vacuum thermocompressor ⁶⁹. Compressing the substrates together using rollers at hot temperatures is also performed in thermal lamination techniques ^{56,57,76}. The print, cut and laminate (PCL) approach has been shown to be an effective, inexpensive way to fabricate thermoplastic microfluidics made of PET or other such polymers ^{102,103}. COC and PMMA microfluidic devices are widely fabricated

using thermal fusion bonding method^{18,21,32,53}. For example, thermal fusion bonding at 145 °C under 35 kPa was done to bond COC layers¹⁸. Moreover, PC-PC bonding was performed through thermal bonding at 143 °C and under 0.9 MPa pressure for 2 min¹⁵. Exposure of thermoplastic polymers to UV light before thermal fusion bonding can reduce the bonding temperature to below the T_g as a short-wavelength UV light is able to break polymer chains at the surface of the polymer¹⁰⁴. Roy *et al.* UV grafted different monomers of acrylic acid (AAc), acrylamide (AAm), 2-hydroxyethyl methacrylate (HEMA), and N-vinylpyrrolidone (NVP) using BP photoinitiator, to indicate the best biocompatibility and ability to bond to another COC substrate at low temperature³². All the grafted coatings resulted in strong COC thermal fusion bonding at temperatures below the T_g of COC. UV light was also incorporated in Ongaro *et al.*'s work to bond PLA substrates together at a lower temperature. In their protocol, after UV exposure for 45 s, the substrates were placed in contact at 50 °C for 10 min to complete the bonding⁶². In Busek *et al.*'s study, 0.6 J/cm² was demonstrated as the optimum UV dose for binding PMMA to PMMA as well as PMMA to TPE at 84 °C and 70 °C, respectively (**Figure 3 a**)²⁷. Exposing COP to UVO₃ for 20 min followed by a thermal fusion bonding step has also resulted in good strength bonding between two COP layers⁶⁰.

Transparency of the microfluidic device, resolution and precision of the microchannels, and bonding strength are important parameters that should be taken into consideration when an appropriate bonding method is selected. Thermal fusion bonding is a very fast technique to bond thermoplastic layers. However, it requires high pressure and temperature, which hinders its potential for the low-cost mass production of microfluidic devices. Deformation of channels after thermal diffusion bonding is also very plausible as this process is usually performed at temperature above the T_g . Furthermore, in this process, the layers cannot be bio-functionalized prior to bonding

as the high temperature used in this method would denature immobilized proteins and eliminate functional groups. Thus, the functionalization process should be performed after channel bonding which can be more challenging considering the limited access to the inner surface of the channel after bonding.

3.2 Solvent bonding

In this method, the applied solvent diffuses across the polymer interface and dissolves the polymer chains making them mobile. The polymer substrates are compressed and as the solvent evaporates, the induced mobile chains are entangled in each other at the interface and create a strong bonding force²². In order to avoid deformation of the polymer by the solvent, it is carried out at very low solvent concentrations, which increases the required bonding time¹⁰⁵. Solvent bonding is usually stronger when it is used for bonding layers with the same material combinations and when it is integrated with thermal bonding⁶⁰.

For COC substrates, it is known that polar organic solvents cannot dissolve the polymer while non-polar organic solvents such as hydrocarbons can dissolve it well¹⁰⁶. As an example, in order to bond COC channels to a COC flat layer, the flat layer could be exposed to saturated methylcyclohexane vapor for 15 s at 30 °C followed by immediate contact to the COC channels at 85 °C for 15 min under 1 MPa pressure¹⁷. In another study, a COC lid was immersed in 15% decalin diluted in ethanol for 5 min to plasticize the COC. The layer was brought into contact with another COC layer with 1.7 MPa pressure at a temperature below the glass transition temperature²³. Bruijns *et al.* exposed the COC substrates to a solution containing 40 vol% cyclohexane and 60 vol% acetone for 2 min⁷³. Afterwards, the substrates were bonded together at room temperature under a weight of 2 kg.

PC-PC bonding has also been studied via solvent bonding using an acetone and n-pentane mixture (**Figure 3 b**)²². The process initially involved immersing two PC substrates, one with patterned microfluidic channels and one without, into a solvent containing acetone, n-pentane, and 1H,1H,2H,2H-perfluorooctyl trichlorosilane (FOTS)²². The n-pentane solution acts as a sacrificial solvent and evaporates faster leaving temporary high concentrations of the acetone for dissolving the substrate. The substrates were inserted into a heat roller with a pressure of 0.1 MPa, which results in the mobilized polymeric chains being entangled. The use of FOTS provides hydrophobicity after the bonding, which is not normally achievable as the surface energy of the substrates are usually increased in the bonding process to obtain better adhesion. Mirgissa *et al.* placed PC substrates at a certain distance from a chloroform pool to create surface swollen regions containing mobile polymeric chains for solvent bonding⁵². The solvent bonding was followed by thermal bonding at 125 °C to ensure the robustness of the bonding. They claimed that utilization of chloroform facilitated the thermal bonding process, which is normally conducted at higher temperatures and pressures for longer periods of time compared to their protocol.

PMMA-PMMA bonding has also been done by UV and solvent assisted method, where the substrates were first soaked in ethanol and then aligned together and exposed to UV for 20 min⁵⁴. Ethanol as a non-toxic solvent can dissolve PMMA and form acrylate monomers which diffuse across the interface of two layers and results in strong bonding upon the exposure of UV light. The device needed to be kept at 120 °C for 2 hours under 1 kg weight⁵⁴. Doung *et al.* applied the same method to make a hybrid PLA/PMMA microfluidic device¹⁰⁷. They used a spin coater to uniformly spread ethanol onto the layers to prevent bubble formation. The bonding was performed at a low temperature of 55 °C. In another study, Doung *et al.* sprayed ethanol onto PMMA and ABS layers for bonding⁸⁵. After bringing the layers in contact, the device was put under UV to

generate the temperature (55 °C to 60 °C) needed for dissolving the surface layer of PMMA. They also performed a post-heat treatment to release the residual stress caused after UV exposure. In order to enhance the efficiency of solvent bonding method, grooves were embedded in Persson *et al.*'s design to retain solvent in the vicinity of microchannels. Using SciGrip 4 as the solvent, they managed to create strong bonding between PMMA microchannels sandwiching a PETE membrane (**Figure 3 c**)⁶¹.

Solvent bonding is usually not compatible with pre-functionalization as well, since normally both top and bottom thermoplastic layers should be treated with the solvent, which can eliminate the functional groups and denature the immobilized biomolecules. This method is achievable without denaturing pre-immobilized biomolecules only if the lid polymer layer (without the immobilized biomolecules) is in contact with the solvent. Moreover, the solvent bonding should be done at room temperature to maintain the functionality of the biomolecules, and the transparency of the layers should not deteriorate. PMMA-PMMA bonding at room temperature could be done using ethyl acetate and isopropanol (35:65%v/v) together with the lamination technique²⁹. Furthermore, Keller *et al.* used 35% cyclohexane in acetone to dissolve a COC polymer layer causing it to become “tacky”⁹⁹. They chose a non-penetrating polar acetone solvent to inhibit the excessive diffusion of the non-polar cyclohexane solvent into COC which can result in bubble formation and lack of transparency. In the proposed protocol the COC with an array of pre-immobilized biotin was bonded with another COC lid layer that had become tacky. They proved that the bonding technique does not denature the biotin compared to thermal fusion bonding.

In general, solvent bonding is a longer process than thermal fusion bonding, but it does not require high temperatures, which could potentially reduce the fabrication cost. In solvent bonding, overexposure of the substrates to the solvent can result in deformation of the microfluidic channels

and solvent residue could adversely affect the functionality of immobilized biomolecules. Therefore, the exposure time and concentration of the solvent are important factors in this method.

3.3 Chemical bonding

Chemical bonding involves equipping the polymeric layers with functional groups and causing covalent reactions between these groups at the interface when the layers are brought into contact. Silanization in particular, was used in Pečar *et al.*'s work to bond thermoplastic substrates such as PC, acrylonitrile butadiene styrene (ABS) and PMMA to PDMS microchannels¹⁰⁸. The oxygen plasma treated thermoplastic substrates were coated with either a 5% 3-aminopropyltriethoxysilane (APTES) or a poly [dimethyl siloxane-co-(3-aminopropyl) methyl siloxane (Amine-PDMS)]. After proper heat treatment, the amine-functionalized thermoplastic substrates together with PDMS were again oxygen plasma treated and brought into contact using methanol as an aligning medium, followed by an additional curing at 80°C for 1 h. Similarly, Sivakumar *et al.* chemically modified the surface of PDMS using anhydride silane and amino silane reagents resulting in a permanent bond with PET at room temperature *via* the formation of a stable succinimide group without the requirement of additional pressure to initiate bonding. The hybrid PDMS-PET microfluidic channel can thus be used in high-pressure experiments such as the separation of blood and plasma¹⁰⁹. Bis-[3- (trimethoxysilyl)-propyl]-amine (Bisamino Silane) has also been utilized to bind PC/TPE-hybrid layers to different substrates such as TPE, COC, PS, PC, and glass²⁸.

APTES treatment is also a common strategy for irreversible bonding of nano porous membranes such as PC, polyethersulfone (PES), and polyester terephthalate (PETE) to different substrates for organs-on-chips applications^{60,110}. In this protocol, subsequent to O₂ plasma activation, the

membrane is submerged in a 5% APTES solution (diluted in DI water) at 80 °C for 20 min. Pressing the APTES treated membrane against a O₂ plasma activated layer leads to an irreversible bonding between the layers. It is worth mentioning that corona discharge method is not recommended for hydroxylation of membranes as it could damage the homogeneity of the membrane ¹¹⁰.

It has been shown that although silanization is an effective way to bond COC to PDMS, it is not generally applicable for COC-COC bonding ²³. CVD polymerization of 4-aminomethyl[2.2]paracyclophane and 4-formyl[2.2] paracyclophane approach introduced by Chen *et al.* could also be a potential way for chemical bonding of thermoplastic polymers ¹¹¹. The CVD treatment involved sublimation of the precursors in vacuum and condensation of the precursors on the substrates at 15 °C. The induced poly(4-aminomethyl-p-xylylene)-co-(p-xylylene) (polymer 1) and poly(4-formyl-p-xylylene-co-p-xylylene) (polymer 2) coatings on the two layers of the microfluidic device could covalently bind to each other through the reaction between the amine groups of polymer 1 and aldehyde groups of polymer 2. To accomplish the covalent bonding, the substrates were placed in touch at 140 °C for 3 h. Use of initiated chemical vapor deposition (iCVD) is another way for chemical bonding of polymers ^{100,101}. iCVD is a solvent-free process where a monomer together with an initiator are simultaneously introduced to the substrate at gas phase. A heating filament is used in the chamber to thermally radicalize the initiator at 150–300 °C ¹¹². The radicals react with the adsorbed monomer on the cool substrate and initiate polymerization. As iCVD is solvent-free and the polymer is maintained at (15–40 °C), the process does not generate delamination, swelling, shrinkage, or wrinkling on the membrane or sensitive polymers ¹¹². Im *et al.* employed this technique for chemical bonding of different polymers such as PDMS, PS petri dishes, PET, PC, and poly(tetrafluoro ethylene) (PTFE) ¹⁰⁰. In the proposed protocol, allylamine plasma treatment was done to create polyallylamine (PAAm) on

one layer. Poly(glycidyl methacrylate) (PGMA) formed another layer via iCVD using tertbutyl peroxide as the initiator and glycidyl methacrylate as the monomer. Oxygen plasma treatment prior to the coatings promoted adhesion for polymers with low surface energies such as PTFE. After the coatings, the substrates were brought into contact under 0.1 bar pressure at 70 °C. The layers could covalently bind owing to the ring opening reaction between the epoxy and amine terminations.

iCVD method is also used in a work done by Xu *et al.*¹⁰¹. Here, tert-Butyl peroxide was used as the initiator and 4-Aminostyrene (4-AS) as well as glycidyl methacrylate (GMA) as the monomers to create poly(glycidyl methacrylate) (PGMA) and poly(4-aminostyrene) (PAS) coatings, respectively. The process was applied on different substrates including PDMS, PC, PET, polyethylene (PE), polyacrylate (PA), and COC. Before iCVD, the substrates were oxygen plasma treated for better adhesion. PGMA and PAS films were polymerized on the flat and channelled layers, respectively. The layers could covalently bind without any need for high pressure or temperature. Moreover, the remaining functional groups inside the sealed channel could further be incorporated in covalent immobilization of biomolecules. They demonstrated this via the attachment of conjugated quantum dots via DCC chemistry (**Figure 3 d**).

In comparison to thermal fusion and solvent bonding, chemical bonding allows for simultaneous functionalization of the inner surface of microchannels as the reactive chemical groups induced for bonding the two layers can also be incorporated for further covalent attachment of biomolecules. The other advantage of this method is the superior bonding strength as a result of covalent bonding of layers. Moreover, it is possible to conduct the bonding at low temperatures and pressures, which preserves the precision of the channels' geometry better than thermal and solvent bonding¹⁰¹. The disadvantage of this method is the many steps involved for chemical treatment of the layers, which makes it troublesome for commercialization.

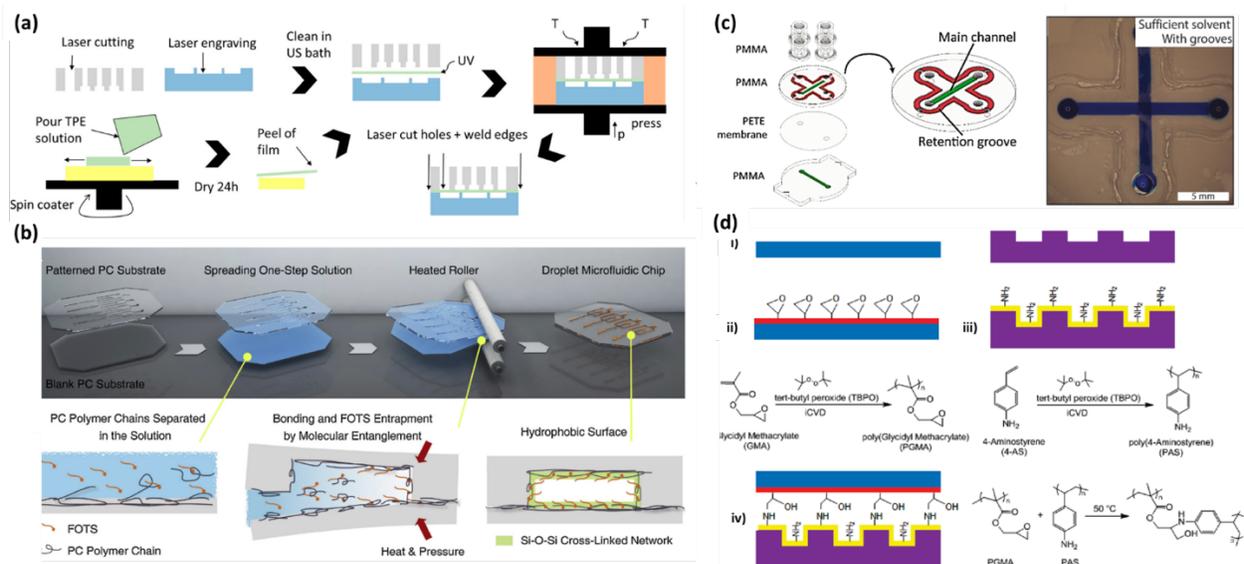


Figure 3. (a) Fabrication process of laser cut PMMA microchannels (pneumatic channels in gray and a fluidic channel in blue) sandwiching a TPE film. The device was bonded via UV assisted thermal fusion bonding. Reprinted from Ref. ²⁷ with permission from MDPI. (b) Solvent bonding of PC microfluidic channels. FOTS molecules are entangled with the polymer chains and hydrolysed. Reprinted from Ref. ²² with permission from Elsevier. (c) Retention grooves embedded in microfluidic design to promote the solving bonding process in a PMMA-based microfluidic device. Reprinted from Ref. ⁶¹ with permission from Elsevier. (d) Chemical bonding of thermoplastic layers via iCVD polymerization of poly(glycidyl methacrylate) (PGMA) and poly(4-aminostyrene) (PAS). Reprinted from Ref. ¹⁰¹ with permission from ACS publications.

3.4 Ultrasonic welding

Ultrasonic vibration can also be utilized as the heating source, which significantly expedites the bonding process ³⁰. This process offers high bonding strength in a very short time, making it a good strategy for rapid prototyping. By controlling the pressure, power, and time, the bonding process can be optimized. Ultrasonic welding enables us to locally bond specific regions of the microfluidic layers. Thus, unlike conventional thermal bonding where the temperature of the entire chip is kept above the glass transition temperature, which can denature the preloaded biomolecules

or possibly deform the channels, here, the generated heat energy is focused on energy directors (ED) at the specific regions that need to be bonded. The energy directors are essentially convex structures around the channels which are melted during ultrasonic vibration and stick the layers together. The melting flow, however, could leave a small gap between the bonding layers or could flow into the channels and clog the microchannels. In order to tackle this problem, Liang *et al.*'s incorporated a CO₂ laser ablation system in the ultrasonic welding process¹¹³. Using the CO₂ laser cutter, they formed grooves and laser bulges as the energy director. Therefore, during the welding process, the melted laser bulges could flow into the grooves and consequently prevent the gap and clogging issues (**Figure 4 a**). Viehrig *et al.* also used laser ablation to engrave grooves on an aluminum-based master mold created by micro-milling technique⁴⁴. The grooves were 50 μm in both depth and width and served as energy directors in ultrasonic welding. Ultrasonic welding can also be employed for bonding microfluidic connectors and luer lock fittings to the device¹¹⁴.

3.5 Laser welding

Another approach to bond thermoplastic polymers is laser welding. In this process, the substrates are held in contact and a laser beam is transferred through the whole platform to reach and melt the materials at the interface for bonding. Similar to the ultrasonic welding, this process also creates localized heating and can rapidly bond the layers together. However, the transparency of the substrates is an important matter in laser welding. The top layer should be sufficiently thin and transparent to the laser wavelength so that the laser does not lose the required energy for melting the interface while it is passing through the top layer. On the other hand, the bottom layer should be absorbent to the laser beam so as to be able to heat the interface by absorbing the laser energy. To make the bottom layer opaque to the laser beam, usually carbon black (CB) pigments are used. As an example, Archerjee *et al.* investigated laser welding of PMMA to ABS via a diode laser at

809.4 nm wavelength ¹¹⁵. In their study, the transparent PMMA was placed at top and the opaque ABS with 0.1 wt% of CB pigments was placed at the bottom. The laser power, area of the beam spot, and welding speed are the parameters that should be optimized in laser welding to achieve the best efficiency. Moreover, high clamping pressure and good surface finish of the substrates are required in order to eliminate any air gaps in between, which may cause a weak bond. 0.40 wt% of CB was also melt blended in polystyrene in Juhl *et al.*'s study, allowing for laser bonding to another polystyrene layer ¹¹⁶. The CB can also be added only at the interface between the two layers ¹¹⁷. Nowadays, with advancements in laser beam sources, it is possible to generate lasers at the wavelengths of around 2 μm , namely, by using thulium fibre lasers. This avoids the necessity for an additional absorbent layer as thermoplastic polymers are already absorbent in this range. However, the heat affected zone in these wavelengths is more extended across the thickness of the layers due to the absorbance of laser energy by the thermoplastic polymer along the transmission. Thus, the thermal stress in this technique is normally unavoidable ¹¹⁸. Pelsmaeker *et al.* have conducted a thorough investigation on laser welding of different thermoplastic polymers at a laser wavelength of 2 μm ¹¹⁹.

3.6 Adhesive layers

Pressure sensitive double-sided adhesives such as acrylic and silicone-based tapes have frequently been used for microfluidic device bonding ^{48,60,63,67,120–122}. The adhesive tapes can simply be cut via a laser cutter or a vinyl cutting machine to form the geometry of the microchannels within the tape. Afterwards, the tapes are sandwiched between two flat thermoplastic layers under mild pressures to create an enclosed microfluidic device. Adhesive tapes can greatly expedite manufacturing process of multilayered microfluidic devices and do not deteriorate the

transparency of the device ⁶⁰. Moreover, as adhesive tapes are gas permeable, the intermediate adhesion layer can compensate the impermeable nature of thermoplastic layers, which is a critical factor for cell studies ¹²¹. Another advantage of adhesive tapes is that the substrate can be functionalized and coated with the biomolecule of interest prior to bonding. It is important to consider the cytotoxicity and adsorption properties of the adhesive tapes when they are applied for cell culture and biosensing applications ^{48,123}.

Sathish *et al.* used this strategy to bond a major outer membrane protein (MOMP)-functionalized PMMA substrate to another clear PMMA substrate ¹²⁴. In their design, the geometry of the microchannel was cut out in a double-sided tape via a CO₂ laser cutter and subsequently the tape was sandwiched between the two flat PMMA substrates. Chai *et al.* incorporated a hydraulic thermal press to enhance the bonding strength of a POM microfluidic device bonded via a pressure sensitive adhesive layer ⁶⁷. Mylar tapes have also been laser cut to form the channels and then used for bonding layers made of PS ^{125,126}. Bonding properties of dry adhesive tapes for thermoplastic microfluidics are fully investigated in a work done by Tsao *et al.* ¹²⁷.

UV-curable adhesives are another method for bonding of thermoplastic layers. In this process, the adhesion solution such poly(acrylic acid) (PAA) and Norland Optical Adhesives (NOA) is first spread on the bottom layer using spin coating, for instance, and subsequently the second thermoplastic layer is placed on top. The two parts are pressed together under UV irradiation for a few minutes ^{58,74,128}. Le *et al.* showed that the remaining PAA inside the channel can be used for collagen coating through electrostatic interactions, which is highly beneficial for cell culture and organs-on-chips applications (**Figure 4 b**) ⁷⁴. It is also possible to partially UV cure the adhesive layer on a flat PDMS slap and then transfer it to another substrate through a stamp and stick process. After transferring the pre-cured adhesive layer, the second layer of the microfluidic

channel is placed on top and the device is fully cured under UV light to obtain irreversible bonding¹²⁸. UV curable release adhesives have also been used to achieve reversible bonding. In this method, after bonding the layers, the acrylate oligomers in the adhesive tape can be cross-linked under UV exposure and become rigid, thus losing the adhesive strength⁶⁵.

Liu *et al.*⁵⁸ showed a low temperature bonding method in which they utilized an optically clear adhesive (OCA) film to bind PMMA layers. The device was composed of a cover layer, OCA film, and microchannel layer (**Figure 4 c**). The channel design was initially formed on all of the layers using standard laser ablation. The layers were laminated by a heat pressing at 45 °C for 600 seconds to achieve the most effective bonding area. Afterwards, they perfused a liquid optically clear adhesive (LOCA) into the channel to fill the crevices between the layers. The LOCA was then blown out by nitrogen gas and the thin LOCA coating remaining inside the channel was solidified under UV light for 2 hours.

In order to bond microfluidic devices made of PEG, partially cured or uncured PEG is usually placed between the layers which can then be fully photopolymerized under UV light^{75,77,78}. Particularly, in Liu *et al.*'s work, after formation of the PEG microchannels, a lid PEG layer was injected in a mold and semi-cured. The two PEG substrates were then brought into contact and fully cured via exposure to UV light for 5 s, which led to the formation of covalent bonds between methacryl and acryl residues in both PEG layers. The device was then immediately compressed under a 2.4 kg weight for 3-4 min to be flattened. The device was used for electrophoresis separations of fluorescein isothiocyanate-labeled protein and peptide samples without further modification owing to the adsorption-resistant nature of PEG. Kim *et al.* applied a slight physical pressure of $\sim 10^3$ Pa during the UV curing to make conformal contact (**Figure 2 c**)⁷⁷. The UV exposure was performed for a few minutes to induce crosslinking at the interface creating an

irreversible bond. More interestingly, Tian *et al.* utilized this method to sandwich a porous membrane functionalized with silane-(PEG)₅₀₀₀-NHS between PEG layers ⁷⁸. After covalent attachment of anti-*E. coli* or anti-*S. aureus* antibodies to the membrane through the reaction between NHS ester and amine groups of the antibodies, they utilized the device for electrochemical detection of food-borne pathogens.

Use of PDMS as a glue at the interface could also be an option for providing a strong bonding force ¹²⁹. In this case, a thin layer of uncured or semi-cured PDMS is introduced on the surface of one or both of the bonding layers and after bringing the layers into contact, the platform is heated up to fully solidify the PDMS at the interface thereby fastening the layers to each other. Although PDMS glue and adhesive tapes can provide relatively high bonding strength, the resolution and accuracy of the microchannels are not as good as the other methods. Moreover, regarding the uncured or semi-cured PDMS, the leakage of PDMS into the channel and consequently changing the channel geometry or clogging the channel is a common problem. In addition, PDMS shrinks as the device cools down, resulting in misalignment of the channels.

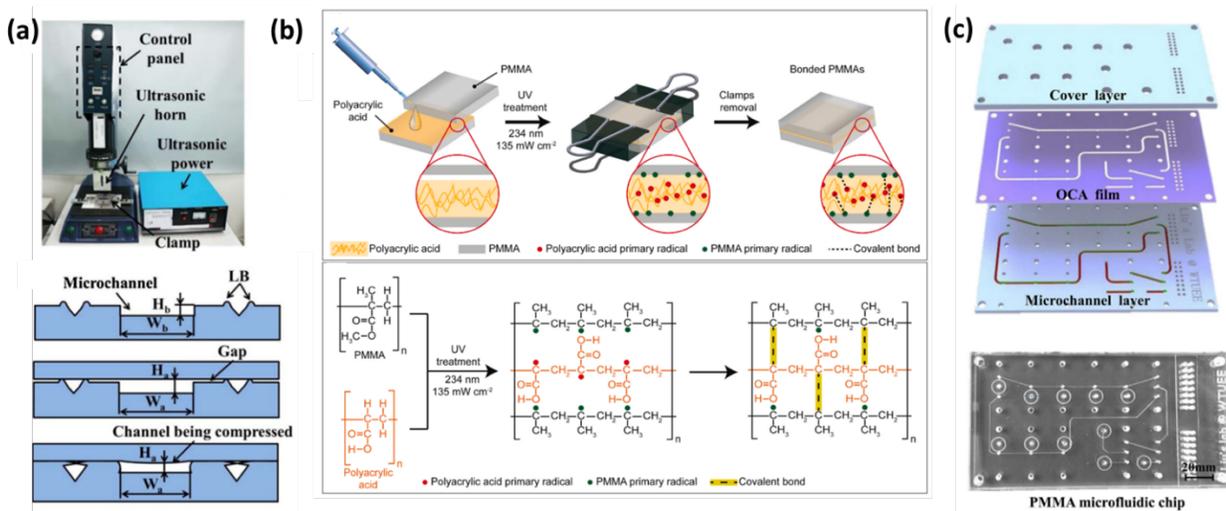


Figure 4. (a) Ultrasonic welding apparatus. In the microchannel design, the laser ablated grooves and bulges can create strong bonding and secure the melted polymer during the ultrasonic welding. Reprinted from Ref. ¹¹³ with permission from Elsevier. **(b)** Bonding PMMA layers through UV-curable PAA adhesive layer. Reprinted from Ref. ⁷⁴ with permission from Elsevier. **(c)** Thermal bonding of PMMA layers using an optically clear adhesive (OCA) film. Reprinted from Ref. ⁵⁸ with permission from Springer.

4 Conclusion and future trend

The use of thermoplastic polymers within microfluidic systems provides a tremendous opportunity for low-cost mass production of microfluidic devices. Replication methods such as hot embossing or injection molding as well as fast prototyping methods including micro-milling and laser ablation represent some of the inexpensive approaches that are compatible with thermoplastics – strategies that are normally not applicable to devices made of PDMS or silicon-based materials ^{5,6,130}. Recently, additive manufacturing and 3D printing techniques have gained a lot of attention for their use in the rapid manufacturing of thermoplastic microfluidics – usually composed of PLA and ABS, due to technological advancements that have yielded effectiveness with complex designs and improved precision. Additive manufacturing of microfluidics is especially useful for the fabrication of innovative monolithic and heterogeneous microfluidics in which multiple layers of chips with different functionalities are stacked together to obtain a small 3D platform exhibiting superior performance. These systems have showed high applicability within complementary metal oxide semiconductor (CMOS)-integrated optical and electrical sensors, microfluidic cooling systems on 2.5D or 3D integrated circuits (ICs), and some other lab-on-a-chip applications ^{131–133}.

Acknowledgements

This work was supported by NSERC Discovery grant, Ontario Early Researcher Award and McMaster Start-up funds to T.F.D. T.F.D are Tier II Canada Research Chairs. This research was undertaken, in part, thanks to funding from the Canada Research Chairs Program (T.F.D).

5 References

- (1) Shakeri, A.; Rahmani, S.; Imani, S. M.; Osborne, M.; Yousefi, H.; Didar, T. F. 26 - Biofunctional Interfaces for Cell Culture in Microfluidic Devices. In *Bioelectronics and Medical Devices: From Materials to Devices - Fabrication, Applications and Reliability*; Pal, K., Kraatz, H.-B., Khasnobish, A., Bag, S., Banerjee, I., Kuruganti, U., Eds.; Woodhead Publishing: Cambridge, Massachusetts, 2019; pp 635–699. <https://doi.org/https://doi.org/10.1016/B978-0-08-102420-1.00033-9>.
- (2) Khan, S.; Burciu, B.; Filipe, C. D. M.; Li, Y.; Dellinger, K.; Didar, T. F. DNAzyme-Based Biosensors: Immobilization Strategies, Applications, and Future Prospective. *ACS Nano* **2021**, *15* (9), 13943–13969. <https://doi.org/10.1021/acsnano.1c04327>.
- (3) Fatanat Didar, T.; Tabrizian, M. Generating Multiplex Gradients of Biomolecules for Controlling Cellular Adhesion in Parallel Microfluidic Channels. *Lab Chip* **2012**, *12* (21), 4363–4371. <https://doi.org/10.1039/c2lc40233e>.
- (4) Didar, T. F.; Bowey, K.; Almazan, G.; Tabrizian, M. A Miniaturized Multipurpose Platform for Rapid, Label-Free, and Simultaneous Separation, Patterning, and in Vitro Culture of

- Primary and Rare Cells. *Adv. Healthc. Mater.* **2014**, *3* (2), 253–260. <https://doi.org/10.1002/adhm.201300099>.
- (5) Shakeri, A.; Sun, N.; Badv, M.; Didar, T. F. Generating 2-Dimensional Concentration Gradients of Biomolecules Using a Simple Microfluidic Design. *Biomicrofluidics* **2017**, *11* (4), 044111. <https://doi.org/10.1063/1.4991550>.
- (6) Shakeri, A.; Imani, S. M.; Chen, E.; Yousefi, H.; Shabbir, R.; Didar, T. F. Plasma-Induced Covalent Immobilization and Patterning of Bioactive Species in Microfluidic Devices. *Lab Chip* **2019**, *19*, 3104–3115. <https://doi.org/10.1039/C9LC00364A>.
- (7) Shakeri, A.; Khan, S.; Didar, T. F. Conventional and Emerging Strategies for the Fabrication and Functionalization of PDMS-Based Microfluidic Devices. *Lab Chip* **2021**, *21* (16), 3053–3075. <https://doi.org/10.1039/d1lc00288k>.
- (8) Shakeri, A.; Jarad, N. A.; Leung, A.; Soleymani, L.; Didar, T. F. Biofunctionalization of Glass- and Paper-Based Microfluidic Devices: A Review. *Adv. Mater. Interfaces* **2019**, *6*, 1900940. <https://doi.org/10.1002/admi.201900940>.
- (9) Gokaltun, A.; Yarmush, M. L.; Asatekin, A.; Usta, O. B. Recent Advances in Nonbiofouling PDMS Surface Modification Strategies Applicable to Microfluidic Technology. *Technology* **2017**, 1–12.
- (10) Park, J. Y.; Yoo, S. J.; Lee, E.-J.; Lee, D. H.; Kim, J. Y.; Lee, S.-H. Increased Poly(Dimethylsiloxane) Stiffness Improves Viability and Morphology of Mouse Fibroblast Cells. *BioChip J.* **2010**, *4* (3), 230–236. <https://doi.org/10.1007/s13206-010-4311-9>.

- (11) Shakeri, A.; Jarad, N. A.; Khan, S.; F Didar, T. Bio-Functionalization of Microfluidic Platforms Made of Thermoplastic Materials: A Review. *Anal. Chim. Acta* **2022**, *1209*, 339283. <https://doi.org/10.1016/j.aca.2021.339283>.
- (12) Tsao, C.-W. Polymer Microfluidics: Simple, Low-Cost Fabrication Process Bridging Academic Lab Research to Commercialized Production. *Micromachines* **2016**, *7* (12), 225. <https://doi.org/10.3390/mi7120225>.
- (13) Badv, M.; Weitz, J. I.; Didar, T. F. Lubricant-Infused PET Grafts with Built-In Biofunctional Nanoprobes Attenuate Thrombin Generation and Promote Targeted Binding of Cells. *Small* **2019**, *15* (51), 1905562. <https://doi.org/10.1002/smll.201905562>.
- (14) Shakeri, A.; Jarad, N. A.; Terryberry, J.; Khan, S.; Leung, A.; Chen, S.; Didar, T. F. Antibody Micropatterned Lubricant-Infused Biosensors Enable Sub-Picogram Immunofluorescence Detection of Interleukin 6 in Human Whole Plasma. *Small* **2020**, *16*, 2003844. <https://doi.org/10.1002/smll.202003844>.
- (15) Ye, M. Y.; Yin, X. F.; Fang, Z. L. DNA Separation with Low-Viscosity Sieving Matrix on Microfabricated Polycarbonate Microfluidic Chips. *Anal. Bioanal. Chem.* **2005**, *381* (4), 820–827. <https://doi.org/10.1007/s00216-004-2988-0>.
- (16) Liu, Y.; Ganser, D.; Schneider, A.; Liu, R.; Grodzinski, P.; Kroutchinina, N. Microfabricated Polycarbonate CE Devices for DNA Analysis. *Anal. Chem.* **2001**, *73* (17), 4196–4201. <https://doi.org/10.1021/ac010343v>.
- (17) Faure, K.; Albert, M.; Dugas, V.; Crétier, G.; Ferrigno, R.; Morin, P.; Rocca, J. L. Development of an Acrylate Monolith in a Cyclo-Olefin Copolymer Microfluidic Device

- for Chip Electrochromatography Separation. *Electrophoresis* **2008**, *29*, 4948–4955.
<https://doi.org/10.1002/elps.200800235>.
- (18) Lee, J. H.; Kim, S. K.; Park, H. H.; Kim, T. S. TiO₂ Coated Microfluidic Devices for Recoverable Hydrophilic and Hydrophobic Patterns. *J. Micromechanics Microengineering* **2015**, *25*, 035032. <https://doi.org/10.1088/0960-1317/25/3/035032>.
- (19) Young, E. W. K.; Berthier, E.; Guckenberger, D. J.; Sackmann, E.; Lamers, C.; Meyvantsson, I.; Huttenlocher, A.; Beebe, D. J. Rapid Prototyping of Arrayed Microfluidic Systems in Polystyrene for Cell-Based Assays. *Anal. Chem.* **2011**, *83*, 1408–1417.
- (20) Jackson, J. M.; Witek, M. A.; Hupert, M. L.; Brady, C.; Pullagurla, S.; Kamande, J.; Aufforth, R. D.; Tignanelli, C. J.; Torphy, R. J.; Yeh, J. J.; Soper, S. A. UV Activation of Polymeric High Aspect Ratio Microstructures: Ramifications in Antibody Surface Loading for Circulating Tumor Cell Selection. *Lab Chip* **2014**, *14* (1), 106–117.
<https://doi.org/10.1039/c3lc50618e>.
- (21) Jena, R. K.; Yue, C. Y. Cyclic Olefin Copolymer Based Microfluidic Devices for Biochip Applications: Ultraviolet Surface Grafting Using 2-Methacryloyloxyethyl Phosphorylcholine. *Biomicrofluidics* **2012**, *6* (1), 012822.
<https://doi.org/10.1063/1.3682098>.
- (22) Su, S.; Jing, G.; Zhang, M.; Liu, B.; Zhu, X.; Wang, B.; Fu, M.; Zhu, L.; Cheng, J.; Guo, Y. One-Step Bonding and Hydrophobic Surface Modification Method for Rapid Fabrication of Polycarbonate-Based Droplet Microfluidic Chips. *Sensors Actuators, B Chem.* **2019**, *282* (November 2018), 60–68. <https://doi.org/10.1016/j.snb.2018.11.035>.

- (23) Aghvami, S. A.; Opathalage, A.; Zhang, Z. K.; Ludwig, M.; Heymann, M.; Norton, M.; Wilkins, N.; Fraden, S. Rapid Prototyping of Cyclic Olefin Copolymer (COC) Microfluidic Devices. *Sensors Actuators, B Chem.* **2017**, *247*, 940–949. <https://doi.org/10.1016/j.snb.2017.03.023>.
- (24) Becker, H.; Gärtner, C. Polymer Microfabrication Methods for Microfluidic Analytical Applications. *Electrophoresis* **2000**, *21* (1), 12–26. [https://doi.org/https://doi.org/10.1002/\(SICI\)1522-2683\(20000101\)21:1<12::AID-ELPS12>3.0.CO;2-7](https://doi.org/https://doi.org/10.1002/(SICI)1522-2683(20000101)21:1<12::AID-ELPS12>3.0.CO;2-7).
- (25) Yi, L.; Xiaodong, W.; Fan, Y. Microfluidic Chip Made of COP (Cyclo-Olefin Polymer) and Comparison to PMMA (Polymethylmethacrylate) Microfluidic Chip. *J. Mater. Process. Technol.* **2008**, *208* (1), 63–69. <https://doi.org/https://doi.org/10.1016/j.jmatprotec.2007.12.146>.
- (26) Lachaux, J.; Alcaine, C.; Gómez-Escoda, B.; Perrault, C. M.; Duplan, D. O.; Wu, P.-Y. J.; Ochoa, I.; Fernandez, L.; Mercier, O.; Coudreuse, D.; Roy, E. Thermoplastic Elastomer with Advanced Hydrophilization and Bonding Performances for Rapid (30 s) and Easy Molding of Microfluidic Devices. *Lab Chip* **2017**, *17* (15), 2581–2594. <https://doi.org/10.1039/C7LC00488E>.
- (27) Busek, M.; Nøvik, S.; Aizenshtadt, A.; Amirolo-Martinez, M.; Combriat, T.; Grünzner, S.; Krauss, S. Thermoplastic Elastomer (TPE)–Poly(Methyl Methacrylate) (PMMA) Hybrid Devices for Active Pumping Pdms-Free Organ-on-a-Chip Systems. *Biosensors* **2021**, *11* (5). <https://doi.org/10.3390/bios11050162>.

- (28) Schneider, S.; Brás, E. J. S.; Schneider, O.; Schlünder, K.; Loskill, P. Facile Patterning of Thermoplastic Elastomers and Robust Bonding to Glass and Thermoplastics for Microfluidic Cell Culture and Organ-on-Chip. *Micromachines* **2021**, *12* (5), 575. <https://doi.org/10.3390/mi12050575>.
- (29) Feysa, B.; Liedert, C.; Kivimaki, L.; Johansson, L. S.; Jantunen, H.; Hakalahti, L. Patterned Immobilization of Antibodies within Roll-to-Roll Hot Embossed Polymeric Microfluidic Channels. *PLoS One* **2013**, *8* (7), e68918. <https://doi.org/10.1371/journal.pone.0068918>.
- (30) Runge, T.; Sackmann, J.; Karl, W.; Lars, S.; Blank, M. Ultrasonically Manufactured Microfluidic Device for Yeast Analysis. *Microsyst. Technol.* **2017**, *23* (6), 2139–2144. <https://doi.org/10.1007/s00542-016-3007-z>.
- (31) Attia, U. M.; Marson, S.; Alcock, J. R. Micro-Injection Moulding of Polymer Microfluidic Devices. *Microfluid. Nanofluidics* **2009**, *7* (1), 1–28. <https://doi.org/10.1007/s10404-009-0421-x>.
- (32) Roy, S.; Yue, C. Y.; Venkatraman, S. S.; Ma, L. L. Fabrication of Smart COC Chips: Advantages of N-Vinylpyrrolidone (NVP) Monomer over Other Hydrophilic Monomers. *Sensors Actuators, B Chem.* **2013**, *178*, 86–95. <https://doi.org/10.1016/j.snb.2012.12.058>.
- (33) Büttner, H.; Maradia, U.; Suarez, M.; Stirnimann, J.; Wegener, K. Development of Process Chain for Micro-Injection Molding. *Procedia CIRP* **2020**, *95*, 584–589. <https://doi.org/10.1016/j.procir.2020.03.147>.
- (34) Ogorodnyk, O.; Martinsen, K. Monitoring and Control for Thermoplastics Injection Molding A Review. *Procedia CIRP* **2018**, *67*, 380–385.

<https://doi.org/10.1016/j.procir.2017.12.229>.

- (35) Wang, Y.; Yu, K.-M.; Wang, C. C. L. Spiral and Conformal Cooling in Plastic Injection Molding. *Comput. Des.* **2015**, *63*, 1–11. <https://doi.org/https://doi.org/10.1016/j.cad.2014.11.012>.
- (36) Rahim, S. Z. A.; Sharif, S.; Zain, A. M.; Nasir, S. M.; Mohd Saad, R. Improving the Quality and Productivity of Molded Parts with a New Design of Conformal Cooling Channels for the Injection Molding Process. *Adv. Polym. Technol.* **2016**, *35* (1). <https://doi.org/https://doi.org/10.1002/adv.21524>.
- (37) He, B.; Ying, L.; Li, X.; Hu, P. Optimal Design of Longitudinal Conformal Cooling Channels in Hot Stamping Tools. *Appl. Therm. Eng.* **2016**, *106*, 1176–1189. <https://doi.org/https://doi.org/10.1016/j.applthermaleng.2016.06.113>.
- (38) Chen, S.-C.; Jong, W.-R.; Chang, J.-A. Dynamic Mold Surface Temperature Control Using Induction Heating and Its Effects on the Surface Appearance of Weld Line. *J. Appl. Polym. Sci.* **2006**, *101* (2), 1174–1180. <https://doi.org/https://doi.org/10.1002/app.24070>.
- (39) Wang, G.; Zhao, G.; Li, H.; Guan, Y. Research on a New Variotherm Injection Molding Technology and Its Application on the Molding of a Large LCD Panel. *Polym. Plast. Technol. Eng.* **2009**, *48* (7), 671–681. <https://doi.org/10.1080/03602550902824549>.
- (40) Saito, T.; Satoh, I.; Kurosaki, Y. A New Concept of Active Temperature Control for an Injection Molding Process Using Infrared Radiation Heating. *Polym. Eng. Sci.* **2002**, *42* (12), 2418–2429. <https://doi.org/https://doi.org/10.1002/pen.11128>.

- (41) Ma, X.; Li, R.; Jin, Z.; Fan, Y.; Zhou, X.; Zhang, Y. Injection Molding and Characterization of PMMA-Based Microfluidic Devices. *Microsyst. Technol.* **2020**, *26* (4), 1317–1324. <https://doi.org/10.1007/s00542-019-04662-2>.
- (42) Kim, Y.; Song, J.; Lee, Y.; Cho, S.; Kim, S.; Lee, S. R.; Park, S.; Shin, Y.; Jeon, N. L. High-Throughput Injection Molded Microfluidic Device for Single-Cell Analysis of Spatiotemporal Dynamics. *Lab Chip* **2021**, *21* (16), 3150–3158. <https://doi.org/10.1039/d0lc01245a>.
- (43) Ko, J.; Lee, Y.; Lee, S.; Lee, S. R.; Jeon, N. L. Human Ocular Angiogenesis-Inspired Vascular Models on an Injection-Molded Microfluidic Chip. *Adv. Healthc. Mater.* **2019**, *8* (15), 1–10. <https://doi.org/10.1002/adhm.201900328>.
- (44) Viehrig, M.; Thilsted, A. H.; Matteucci, M.; Wu, K.; Catak, D.; Schmidt, M. S.; Zór, K.; Boisen, A. Injection-Molded Microfluidic Device for SERS Sensing Using Embedded Au-Capped Polymer Nanocones. *ACS Appl. Mater. Interfaces* **2018**, *10* (43), 37417–37425. <https://doi.org/10.1021/acsami.8b13424>.
- (45) Council, N. R. 3. Manufacturing: Materials and Processing. In *Polymer Science and Engineering: The Shifting Research Frontiers*; The National Academies Press: Washington, DC, 1994; pp 65–115. <https://doi.org/10.17226/2307>.
- (46) McKeen, L. W. Chapter 1 - Introduction to Plastics and Polymers. In *Plastics Design Library*; McKeen, L. W. B. T.-F. P. of P. and E. (Third E., Ed.; William Andrew Publishing: Boston, 2012; pp 1–18. <https://doi.org/https://doi.org/10.1016/B978-1-4557-2551-9.00001-3>.

- (47) Jena, R. K.; Yue, C. Y.; Lam, Y. C.; Wang, Z. Y. High Fidelity Hot-Embossing of COC Microdevices Using a One-Step Process without Pre-Annealing of Polymer Substrate. *Sensors Actuators, B Chem.* **2010**, *150* (2), 692–699. <https://doi.org/10.1016/j.snb.2010.08.018>.
- (48) Müller, B.; Sulzer, P.; Walch, M.; Zirath, H.; Buryška, T.; Rothbauer, M.; Ertl, P.; Mayr, T. Measurement of Respiration and Acidification Rates of Mammalian Cells in Thermoplastic Microfluidic Devices. *Sensors Actuators, B Chem.* **2021**, *334* (October 2020), 129664 Contents. <https://doi.org/10.1016/j.snb.2021.129664>.
- (49) Hupert, M. L.; Guy, W. J.; Llopis, S. D.; Shadpour, H.; Rani, S.; Nikitopoulos, D. E.; Soper, S. A. Evaluation of Micromilled Metal Mold Masters for the Replication of Microchip Electrophoresis Devices. *Microfluid. Nanofluidics* **2007**, *3* (1), 1–11. <https://doi.org/10.1007/s10404-006-0091-x>.
- (50) Chantiwas, R.; Hupert, M. L.; Pullagurla, S. R.; Balamurugan, S.; Tamarit-López, J.; Park, S.; Datta, P.; Goettert, J.; Cho, Y. K.; Soper, S. A. Simple Replication Methods for Producing Nanoslits in Thermoplastics and the Transport Dynamics of Double-Stranded DNA through These Slits. *Lab Chip* **2010**, *10* (23), 3255–3264. <https://doi.org/10.1039/c0lc00096e>.
- (51) Subramanian, B.; Kim, N.; Lee, W.; Spivak, D. A.; Nikitopoulos, D. E.; McCarley, R. L.; Soper, S. A. Surface Modification of Droplet Polymeric Microfluidic Devices for the Stable and Continuous Generation of Aqueous Droplets. *Langmuir* **2011**, *27* (12), 7949–7957. <https://doi.org/10.1021/la200298n>.

- (52) Mirgissa, A.; Jeon, H.; Park, A.; Yi, K.; Baek, S.; Park, A.; Kim, D. Cavitation-Microstreaming-Based Lysis and DNA Extraction Using a Laser-Machined Polycarbonate Microfluidic Chip. *Sensors Actuators B. Chem.* **2021**, *346* (April), 130511. <https://doi.org/10.1016/j.snb.2021.130511>.
- (53) Kulsharova, G.; Dimov, N.; Marques, M. P. C.; Szita, N.; Baganz, F. Simplified Immobilisation Method for Histidine-Tagged Enzymes in Poly(Methyl Methacrylate) Microfluidic Devices. *N. Biotechnol.* **2018**, *47* (December 2017), 31–38. <https://doi.org/10.1016/j.nbt.2017.12.004>.
- (54) Bhardwaj, T.; Jha, S. Microfluidic Platform for Aptamer Based Fluorimetric Analysis of Analytes. In *BIOSTEC 2018*; 2018; pp 218–223. <https://doi.org/10.5220/0006645002180223>.
- (55) Roberts, M. A.; Rossier, J. S.; Bercier, P.; Girault, H. UV Laser Machined Polymer Substrates for the Development of Microdiagnostic Systems. *Anal. Chem.* **1997**, *69* (11), 2035–2042. <https://doi.org/10.1021/ac961038q>.
- (56) Liu, Y.; Zhong, W.; Meng, S.; Kong, J.; Lu, H.; Yang, P.; Girault, H. H.; Liu, B. Assembly-Controlled Biocompatible Interface on a Microchip: Strategy to Highly Efficient Proteolysis. *Chem. - A Eur. J.* **2006**, *12* (25), 6585–6591. <https://doi.org/10.1002/chem.200501622>.
- (57) Liu, Y.; Xue, Y.; Ji, J.; Chen, X.; Kong, J.; Yang, P.; Girault, H. H.; Liu, B. Gold Nanoparticle Assembly Microfluidic Reactor for Efficient On-Line Proteolysis. *Mol. Cell. Proteomics* **2007**, *6* (8), 1428–1436. <https://doi.org/10.1074/mcp.T600055-MCP200>.

- (58) Liu, K.; Xiang, J.; Ai, Z.; Zhang, S.; Fang, Y.; Chen, T.; Zhou, Q.; Li, S.; Wang, S.; Zhang, N. PMMA Microfluidic Chip Fabrication Using Laser Ablation and Low Temperature Bonding with OCA Film and LOCA. *Microsyst. Technol.* **2017**, *23* (6), 1937–1942. <https://doi.org/10.1007/s00542-016-2924-1>.
- (59) Liu, S.; Fan, Y.; Gao, K.; Zhang, Y. Fabrication of Cyclo-Olefin Polymer-Based Microfluidic Devices Using CO₂ Laser Ablation. *Mater. Res. Express* **2018**, *5*, 095305.
- (60) Paoli, R.; Di Giuseppe, D.; Badiola-Mateos, M.; Martinelli, E.; Lopez-Martinez, M. J.; Samitier, J. Rapid Manufacturing of Multilayered Microfluidic Devices for Organ on a Chip Applications. *Sensors* **2021**, *21* (4), 1382. <https://doi.org/10.3390/s21041382>.
- (61) Persson, H.; Park, S.; Mohan, M.; Cheung, K. K.; Simmons, C. A.; Young, E. W. K. Rapid Assembly of PMMA Microfluidic Devices with PETE Membranes for Studying the Endothelium. *Sensors Actuators B Chem.* **2022**, *356* (December 2021), 131342. <https://doi.org/10.1016/j.snb.2021.131342>.
- (62) Ongaro, A. E.; Giuseppe, D. Di; Kermanizadeh, A.; Crespo, A. M.; Mencattini, A.; Ghibelli, L.; Mancini, V.; Wlodarczyk, K. L.; Hand, D. P.; Martinelli, E.; Stone, V.; Howarth, N.; Carrubba, V. La; Pensabene, V.; Kersaudy-Kerhoas, M. Polylactic Is a Sustainable, Low Absorption, Low Auto Fluorescence Alternative to Other Plastics for Microfluidic and Organ-on-Chip Applications. *Anal. Biochem.* **2020**, *92*, 6693–6701. <https://doi.org/10.1021/acs.analchem.0c00651>.
- (63) Demuru, S.; Haque, R.; Joho, M. O.; Bionaz, A.; Wal, P. van der; Briand, D. 3D-Integration of Printed Electrochemical Sensors in Pet Microfluidics for Biochemical Sensing. In *2019*

- 20th International Conference on Solid-State Sensors, Actuators and Microsystems & Eurosensors XXXIII (TRANSDUCERS & EUROSENSORS XXXIII)*; 2019; pp 2464–2467.
<https://doi.org/10.1109/TRANSDUCERS.2019.8808497>.
- (64) Jensen, M. F.; Noerholm, M.; Christensen, L. H.; Geschke, O. Microstructure Fabrication with a CO₂ Laser System: Characterization and Fabrication of Cavities Produced by Raster Scanning of the Laser Beam. *Lab Chip* **2003**, *3* (4), 302–307.
<https://doi.org/10.1039/B308153B>.
- (65) Yao, Y.; Li, L.; Jiang, J.; Zhang, Y.; Chen, G.; Fan, Y. Reversible Bonding for Microfluidic Devices with UV Release Tape. *Microfluid. Nanofluidics* **2022**, *26* (3), 23.
<https://doi.org/10.1007/s10404-022-02532-4>.
- (66) Vidya, S.; Wattal, R.; Singh, L.; Mathiyalagan, P. CO₂ Laser Micromachining of Polymethyl Methacrylate (PMMA): A Review. In *Advances in Manufacturing and Industrial Engineering*; Singari, R. M., Mathiyazhagan, K., Kumar, H., Eds.; Springer Singapore: Singapore, 2021; pp 939–945.
- (67) Chai, M.; Cui, R.; Liu, J.; Zhang, Y.; Fan, Y. Polyformaldehyde-Based Microfluidics and Application in Enhanced Oil Recovery. *Microsyst. Technol.* **2021**, *28* (4), 947–954.
<https://doi.org/10.1007/s00542-021-05243-y>.
- (68) Chung, C. K.; Lin, Y. C.; Huang, G. R. Bulge Formation and Improvement of the Polymer in CO₂ Laser Micromachining. *J. Micromechanics Microengineering* **2005**, *15* (10), 1878–1884. <https://doi.org/10.1088/0960-1317/15/10/013>.
- (69) Dong, T.; Pires, N. M. M. Immunodetection of Salivary Biomarkers by an Optical

- Microfluidic Biosensor with Polyethylenimine-Modified Polythiophene-C70 Organic Photodetectors. *Biosens. Bioelectron.* **2017**, *94* (March), 321–327. <https://doi.org/10.1016/j.bios.2017.03.005>.
- (70) Shah, P.; Fritz, J. V.; Glaab, E.; Desai, M. S.; Greenhalgh, K.; Frachet, A.; Niegowska, M.; Estes, M.; Jäger, C.; Seguin-Devaux, C.; Zenhausem, F.; Wilmes, P. A Microfluidics-Based in Vitro Model of the Gastrointestinal Human-Microbe Interface. *Nat. Commun.* **2016**, *7* (May), 11535. <https://doi.org/10.1038/ncomms11535>.
- (71) Kendall, E. L.; Wienhold, E.; Rahmanian, O. D.; Devoe, D. L. Ex Situ Integration of Multifunctional Porous Polymer Monoliths into Thermoplastic Microfluidic Chips. *Sensors Actuators B. Chem.* **2014**, *202*, 866–872. <https://doi.org/10.1016/j.snb.2014.06.023>.
- (72) Garg, M.; Christensen, M. G.; Iles, A.; Sharma, A. L.; Singh, S.; Pamme, N. Microfluidic-Based Electrochemical Immunosensing of Ferritin. *Biosensors* **2020**, *10*, 91.
- (73) Bruijns, B.; Veciana, A.; Tiggelaar, R.; Gardeniers, H. Cyclic Olefin Copolymer Microfluidic Devices for Forensic Applications. *Biosensors* **2019**, *9*, 85.
- (74) Le, N. X. T.; Trinh, K. T. L.; Lee, N. Y. Poly(Acrylic Acid) as an Adhesion Promoter for UV-Assisted Thermoplastic Bonding: Application for the in Vitro Construction of Human Blood Vessels. *Mater. Sci. Eng. C* **2021**, *122* (December 2020), 111874. <https://doi.org/10.1016/j.msec.2021.111874>.
- (75) Liu, J.; Sun, X.; Lee, M. L. Adsorption-Resistant Acrylic Copolymer for Prototyping of Microfluidic Devices for Proteins and Peptides. *Anal. Chem.* **2007**, *79* (5), 1926–1931. <https://doi.org/10.1021/ac0617621>.

- (76) Horak, J.; Dincer, C.; Bakirci, H.; Urban, G. A Disposable Dry Film Photoresist-Based Microcapillary Immunosensor Chip for Rapid Detection of Epstein-Barr Virus Infection. *Sensors Actuators, B Chem.* **2014**, *191*, 813–820. <https://doi.org/10.1016/j.snb.2013.10.019>.
- (77) Kim, P.; Jeong, H. E.; Khademhosseini, A.; Suh, K. Y. Fabrication of Non-Biofouling Polyethylene Glycol Micro- and Nanochannels by Ultraviolet-Assisted Irreversible Sealing. *Lab Chip* **2006**, *6*, 1432–1437. <https://doi.org/10.1039/b610503c>.
- (78) Tian, F.; Lyu, J.; Shi, J.; Tan, F.; Yang, M. A Polymeric Microfluidic Device Integrated with Nanoporous Alumina Membranes for Simultaneous Detection of Multiple Foodborne Pathogens. *Sensors Actuators, B Chem.* **2016**, *225*, 312–318. <https://doi.org/10.1016/j.snb.2015.11.059>.
- (79) Ford, S. M.; Davies, J.; Kar, B.; Qi, S. D.; Mcwhorter, S.; Soper, S. A.; Malek, C. K. Micromachining in Plastics Using X-Ray Lithography for the Fabrication of Micro-Electrophoresis Devices. *J. Biomech. Eng.* **1999**, *121*, 13–21.
- (80) Ford, S. M.; Kar, B.; McWhorter, S.; Davies, J.; Soper, S. A.; Klopf, M.; Calderon, G.; Saile, V. Microcapillary Electrophoresis Devices Fabricated Using Polymeric Substrates and X-Ray Lithography. *J. Microcolumn Sep.* **1998**, *10*, 413–422.
- (81) Chandrasekaran, A.; Kalashnikov, N.; Rayes, R.; Wang, C.; Spicer, J.; Moraes, C. Thermal Scribing to Prototype Plastic Microfluidic Devices, Applied to Study the Formation of Neutrophil Extracellular Traps. *Lab Chip* **2017**, *17*, 2003–2012. <https://doi.org/10.1039/C7LC00356K>.

- (82) Aschenbrenner, D.; Friedrich, O.; Gilbert, D. F. 3D Printed Lab-on-a-Chip Platform for Chemical Stimulation and Parallel Analysis of Ion Channel Function. *Micromachines* **2019**, *10*, 548.
- (83) Yeh, C.; Chen, Y.; Shie, M.; Fang, H. Poly(Dopamine)-Assisted Immobilization of Xu Duan on 3D Printed Poly(Lactic Acid) Scaffolds to Up-Regulate Osteogenic and Angiogenic Markers of Bone Marrow Stem Cells. *Materials (Basel)*. **2015**, *8*, 4299–4315. <https://doi.org/10.3390/ma8074299>.
- (84) Doronin, F. A.; Rudyak, Y. V.; Rytikov, G. O.; Evdokimov, A. G.; Nazarov, V. G. 3D-Printed Planar Microfluidic Device on Oxyfluorinated PET-Substrate. *Polym. Test.* **2021**, *99*, 107209. <https://doi.org/10.1016/j.polymertesting.2021.107209>.
- (85) Duong, L. H.; Chen, P. Simple and Low-Cost Production of Hybrid 3D-Printed Microfluidic Devices. *Biomicrofluidics* **2019**, *13*, 024108. <https://doi.org/10.1063/1.5092529>.
- (86) Pokharna, P. P.; Ghantasala, M. K.; Rozhkova, E. A. 3D Printed Polylactic Acid and Acrylonitrile Butadiene Styrene Fluidic Structures for Biological Applications: Tailoring Bio-Material Interface via Surface Modification. *Mater. Today Commun.* **2021**, *27* (September 2020), 102348. <https://doi.org/10.1016/j.mtcomm.2021.102348>.
- (87) Khatri, A.; Dhawangale, A.; Mukherji, S. Single Step, Mould-Free Fabrication of Polymer Optical Waveguides for Localized Surface Plasmon Resonance Based Sensing Platform. *Sensors Actuators B Chem.* **2019**, *280* (September 2018), 243–255. <https://doi.org/10.1016/j.snb.2018.10.041>.
- (88) Mi, S.; Du, Z.; Xu, Y.; Sun, W. The Crossing and Integration between Microfluidic

- Technology and 3D Printing for Organ-on-Chips. *J. Mater. Chem. B* **2018**, *6*, 6191–6206.
<https://doi.org/10.1039/c8tb01661e>.
- (89) Padash, M.; Enz, C.; Carrara, S. Microfluidics by Additive Manufacturing for Wearable Biosensors: A Review. *Sensors* **2020**, *20*, 4236.
- (90) Roos, M. M.; Winkler, A.; Nilsen, M.; Menzel, S. B.; Strehle, S. Towards Green 3D-Microfabrication of Bio-MEMS Devices Using ADEX Dry Film Photoresists. *Int. J. Precis. Eng. Manuf. Technol.* **2021**. <https://doi.org/10.1007/s40684-021-00367-y>.
- (91) Xie, X.; Maharjan, S.; Liu, S.; Zhang, Y. S.; Livermore, C. A Modular, Reconfigurable Microfabricated Assembly Platform for Microfluidic Transport and Multitype Cell Culture and Drug Testing. *Micromachines* **2020**, *11*, 2.
- (92) Cao, Y.; Floehr, J.; Ingebrandt, S.; Schnakenberg, U. Dry Film Resist Laminated Microfluidic System for Electrical Impedance Measurements. *Micromachines* **2021**, *12*, 632.
- (93) Trantidou, T.; Regoutz, A.; Voon, X. N.; Payne, D. J.; Ces, O. A “Cleanroom-Free” and Scalable Manufacturing Technology for the Microfluidic Generation of Lipid-Stabilized Droplets and Cell-Sized Multisomes. *Sensors Actuators B Chem.* **2018**, *267*, 34–41.
<https://doi.org/10.1016/j.snb.2018.03.165>.
- (94) El Fissi, L.; Vandormael, D.; Francis, L. A. Direct Assembly of Cyclic Olefin Copolymer Microfluidic Devices Helped by Dry Photoresist. *Sensors Actuators A Phys.* **2015**, *223*, 76–83. <https://doi.org/https://doi.org/10.1016/j.sna.2014.12.016>.

- (95) Leech, P. W.; Wu, N.; Zhu, Y. Application of Dry Film Resist in the Fabrication of Microfluidic Chips for Droplet Generation. *J. Micromechanics Microengineering* **2009**, *19* (6), 65019. <https://doi.org/10.1088/0960-1317/19/6/065019>.
- (96) Paul, D.; Saias, L.; Pedinotti, J.-C.; Chabert, M.; Magnifico, S.; Pallandre, A.; De Lambert, B.; Houdayer, C.; Brugg, B.; Peyrin, J.-M.; Viovy, J.-L. A “Dry and Wet Hybrid” Lithography Technique for Multilevel Replication Templates: Applications to Microfluidic Neuron Culture and Two-Phase Global Mixing. *Biomicrofluidics* **2011**, *5* (2), 24102. <https://doi.org/10.1063/1.3569946>.
- (97) Welle, A.; Gottwald, E. UV-Based Patterning of Polymeric Substrates for Cell Culture Applications. *Biomed. Microdevices* **2002**, *4* (1), 33–41. <https://doi.org/10.1023/A:1014267712144>.
- (98) Didar, T. F.; Li, K.; Tabrizian, M.; Veres, T. High Throughput Multilayer Microfluidic Particle Separation Platform Using Embedded Thermoplastic-Based Micropumping. *Lab Chip* **2013**, *13* (13), 2615–2622.
- (99) Keller, N.; Nargang, T. M.; Runck, M.; Kotz, F.; Striegel, A.; Sachsenheimer, K.; Klemm, D.; Länge, K.; Worgull, M.; Richter, C.; Helmer, D.; Rapp, B. E. Tacky Cyclic Olefin Copolymer: A Biocompatible Bonding Technique for the Fabrication of Microfluidic Channels in COC. *Lab Chip* **2016**, *16*, 1561–1564. <https://doi.org/10.1039/c5lc01498k>.
- (100) Im, S. G.; Bong, K. W.; Lee, C. H.; Doyle, P. S.; Gleason, K. K. A Conformal Nano-Adhesive via Initiated Chemical Vapor Deposition for Microfluidic Devices. *Lab Chip* **2009**, *9* (3), 411–416. <https://doi.org/10.1039/b812121d>.

- (101) Xu, J.; Gleason, K. K. Conformal, Amine-Functionalized Thin Films by Initiated Chemical Vapor Deposition (ICVD) for Hydrolytically Stable Microfluidic Devices. *Chem. Mater.* **2010**, *22* (5), 1732–1738. <https://doi.org/10.1021/cm903156a>.
- (102) Ma, H. L.; Urbaczek, A. C.; Souza, F. Z. R. de; Leão, P. A. G. G. C.; Perussi, J. R.; Carrilho, E. Rapid Fabrication of Microfluidic Devices for Biological Mimicking: A Survey of Materials and Biocompatibility. *Micromachines* **2021**, *12*, 346.
- (103) Thompson, B. L.; Ouyang, Y.; Duarte, G. R. M.; Carrilho, E.; Krauss, S. T.; Landers, J. P. Inexpensive, Rapid Prototyping of Microfluidic Devices Using Overhead Transparencies and a Laser Print, Cut and Laminate Fabrication Method. *Nat. Protoc.* **2015**, *10* (6), 875–886. <https://doi.org/10.1038/nprot.2015.051>.
- (104) Gleichweit, E.; Baumgartner, C.; Diethardt, R.; Murer, A.; Sallegger, W.; Werkl, D.; Köstler, S. UV/Ozone Surface Treatment for Bonding of Elastomeric COC-Based Microfluidic Devices. *Proceedings* **2018**, *2* (13), 943. <https://doi.org/10.3390/proceedings2130943>.
- (105) Wan, A. M. D.; Sadri, A.; Young, E. W. K. Liquid Phase Solvent Bonding of Plastic Microfluidic Devices Assisted by Retention Grooves. *Lab Chip* **2015**, *15* (18), 3785–3792. <https://doi.org/10.1039/C5LC00729A>.
- (106) Hansen, C. M.; Just, L. Prediction of Environmental Stress Cracking in Plastics with Hansen Solubility Parameters. *Ind. Eng. Chem. Res.* **2001**, *40* (1), 21–25. <https://doi.org/10.1021/ie9904955>.
- (107) Duong, L. H.; Chen, P. Novel Solvent Bonding Method for Creation of a Three-

- Dimensional, Non-Planar, Hybrid PLA/PMMA Microfluidic Chip. *Sensors Actuators A Phys.* **2018**, *280*, 350–358. <https://doi.org/10.1016/j.sna.2018.08.002>.
- (108) Pečar, B.; Možek, M.; Vrtačnik, D. Thermoplastic - PDMS Polymer Covalent Bonding for Microfluidic Applications. *Inf. MIDE M* **2017**, *47* (3), 147–154.
- (109) Sivakumar, R.; Lee, N. Y. Chemically Robust Succinimide-Group-Assisted Irreversible Bonding of Poly(Dimethylsiloxane)–Thermoplastic Microfluidic Devices at Room Temperature. *Analyst* **2020**, *145* (21), 6887–6894. <https://doi.org/10.1039/D0AN01268H>.
- (110) Aran, K.; Sasso, L. A.; Kamdar, N.; Zahn, J. D. Irreversible, Direct Bonding of Nanoporous Polymer Membranes to PDMS or Glass Microdevices. *Lab Chip* **2010**, *10* (5), 548–552. <https://doi.org/10.1039/b924816a>.
- (111) Chen, H. Y.; McClelland, A. A.; Chen, Z.; Lahann, J. Solventless Adhesive Bonding Using Reactive Polymer Coatings. *Anal. Chem.* **2008**, *80* (11), 4119–4124. <https://doi.org/10.1021/ac800341m>.
- (112) Yu, S. J.; Pak, K.; Kwak, M. J.; Joo, M.; Kim, B. J.; Oh, M. S.; Baek, J.; Park, H.; Choi, G.; Kim, D. H.; Choi, J.; Choi, Y.; Shin, J.; Moon, H.; Lee, E.; Im, S. G. Initiated Chemical Vapor Deposition: A Versatile Tool for Various Device Applications. *Adv. Eng. Mater.* **2018**, *20* (3), 1–37. <https://doi.org/10.1002/adem.201700622>.
- (113) Liang, C.; Meng, F.; Li, J.; Liu, C. Using CO₂-Laser Bugle for Ultrasonic Bonding of Thermoplastic Microfluidic Devices. *J. Mater. Process. Tech.* **2018**, *252* (August 2017), 25–33. <https://doi.org/10.1016/j.jmatprotec.2017.08.030>.

- (114) Finkbeiner, T.; Soergel, H. L.; Koschitzky, M. P.; Ahrens, R.; Guber, A. E. Ultrasonic Welding for the Rapid Integration of Fluidic Connectors into Microfluidic Chips. *J. Micromechanics Microengineering* **2019**, *29*, 065011.
- (115) Acherjee, B.; Kuar, A. S.; Mitra, S.; Misra, D.; Acharyya, S. Experimental Investigation on Laser Transmission Welding of PMMA to ABS via Response Surface Modeling. *Opt. Laser Technol.* **2012**, *44* (5), 1372–1383. <https://doi.org/10.1016/j.optlastec.2011.12.029>.
- (116) Juhl, T. B.; Christiansen, J. D. C.; Jensen, E. A. Mechanical Testing of Polystyrene/Polystyrene Laser Welds. *Polym. Test.* **2013**, *32* (3), 475–481. <https://doi.org/10.1016/j.polymertesting.2013.01.009>.
- (117) Chen, M.; Zak, G.; Bates, P. J. Effect of Carbon Black on Light Transmission in Laser Welding of Thermoplastics. *J. Mater. Process. Tech.* **2011**, *211* (1), 43–47. <https://doi.org/10.1016/j.jmatprotec.2010.08.017>.
- (118) Nguyen, N.; Brosda, M.; Olowinsky, A.; Gillner, A. Absorber-Free Quasi-Simultaneous Laser Welding For Microfluidic Applications. *J. Laser Micro/Nanoengineering* **2019**, *14* (3), 255–261. <https://doi.org/10.2961/jlmn.2019.03.0009>.
- (119) Pelsmaeker, J. De; Graulus, G.; Vlierberghe, S. Van; Thienpont, H.; Hemelrijck, D. Van; Dubruel, P.; Ottevaere, H. Clear to Clear Laser Welding for Joining Thermoplastic Polymers: A Comparative Study Based on Physicochemical Characterization. *J. Mater. Process. Tech.* **2018**, *255* (October 2017), 808–815. <https://doi.org/10.1016/j.jmatprotec.2017.12.011>.
- (120) Schütte, J.; Freudigmann, C.; Benz, K.; Böttger, J.; Gebhardt, R.; Stelzle, M. A Method for

- Patterned in Situ Biofunctionalization in Injection-Molded Microfluidic Devices. *Lab Chip* **2010**, *10* (19), 2551–2558. <https://doi.org/10.1039/c005307d>.
- (121) Kratz, S. R. A.; Eilenberger, C.; Schuller, P.; Bachmann, B.; Spitz, S.; Ertl, P.; Rothbauer, M. Characterization of Four Functional Biocompatible Pressure-Sensitive Adhesives for Rapid Prototyping of Cell-Based Lab-on-a-Chip and Organ-on-a-Chip Systems. *Sci. Rep.* **2019**, *9* (1), 9287. <https://doi.org/10.1038/s41598-019-45633-x>.
- (122) Badv, M.; Alonso-Cantu, C.; Shakeri, A.; Hosseinidoust, Z.; Weitz, J. I.; Didar, T. F. Biofunctional Lubricant-Infused Vascular Grafts Functionalized with Silanized Bio-Inks Suppress Thrombin Generation and Promote Endothelialization. *ACS Biomater. Sci. Eng.* **2019**, *5* (12), 6485–6496. <https://doi.org/10.1021/acsbiomaterials.9b01062>.
- (123) Roy, E.; Galas, J.-C.; Veres, T. Thermoplastic Elastomers for Microfluidics: Towards a High-Throughput Fabrication Method of Multilayered Microfluidic Devices. *Lab Chip* **2011**, *11* (18), 3193–3196. <https://doi.org/10.1039/C1LC20251K>.
- (124) Sathish, S.; Toda-peters, K.; Shen, A. Q. Proof-of-Concept Modular Fluid Handling Prototype Integrated with Microfluidic Biochemical Assay Modules for Point-of-Care. *VIEW* **2020**, *1* (January), e1. <https://doi.org/10.1002/viw2.1>.
- (125) Darain, F.; Gan, K. L.; Tjin, S. C. Antibody Immobilization on to Polystyrene Substrate - On-Chip Immunoassay for Horse IgG Based on Fluorescence. *Biomed. Microdevices* **2009**, *11* (3), 653–661. <https://doi.org/10.1007/s10544-008-9275-3>.
- (126) Darain, F.; Yager, P.; Gan, K. L.; Tjin, S. C. On-Chip Detection of Myoglobin Based on Fluorescence. *Biosens. Bioelectron.* **2009**, *24* (6), 1744–1750.

<https://doi.org/10.1016/j.bios.2008.09.004>.

- (127) Tsao, C.; Syu, W. Bonding of Thermoplastic Microfluidics by Using Dry Adhesive Tape. *RSC Adv.* **2020**, *10*, 30289–30296. <https://doi.org/10.1039/d0ra05876a>.
- (128) Arayanarakool, R.; Le Gac, S.; Van Den Berg, A. Low-Temperature, Simple and Fast Integration Technique of Microfluidic Chips by Using a UV-Curable Adhesive. *Lab Chip* **2010**, *10* (16), 2115–2121. <https://doi.org/10.1039/c004436a>.
- (129) Jeong, S.; Kim, S.; Buonocore, J.; Park, J.; Welsh, C. J.; Li, J.; Han, A. A Three-Dimensional Arrayed Microfluidic Blood–Brain Barrier Model With Integrated Electrical Sensor Array. *IEEE Trans. Biomed. Eng.* **2018**, *65* (2), 431–439. <https://doi.org/10.1109/TBME.2017.2773463>.
- (130) Villegas, M.; Cetinic, Z.; Shakeri, A.; Didar, T. F. Fabricating Smooth PDMS Microfluidic Channels from Low-Resolution 3D Printed Molds Using an Omniphobic Lubricant-Infused Coating. *Anal. Chim. Acta* **2018**, *1000*, 248–255. <https://doi.org/https://doi.org/10.1016/j.aca.2017.11.063>.
- (131) Beckwith, A. L.; Borenstein, J. T.; Velásquez-García, L. F. Monolithic, 3D-Printed Microfluidic Platform for Recapitulation of Dynamic Tumor Microenvironments. *J. Microelectromechanical Syst.* **2018**, *27* (6), 1009–1022. <https://doi.org/10.1109/JMEMS.2018.2869327>.
- (132) Rajan, S. K.; Kaul, A.; Sarvey, T.; May, G. S.; Bakir, M. S. Design Considerations, Demonstration, and Benchmarking of Silicon Microcold Plate and Monolithic Microfluidic Cooling for 2.5D ICs. In *2021 IEEE 71st Electronic Components and Technology*

Conference (ECTC); 2021; pp 1418–1426.
<https://doi.org/10.1109/ECTC32696.2021.00227>.

- (133) Lindsay, M.; Bishop, K.; Sengupta, S.; Co, M.; Cumbie, M.; Chen, C.; Johnston, M. L. Heterogeneous Integration of CMOS Sensors and Fluidic Networks Using Wafer-Level Molding. *IEEE Trans. Biomed. Circuits Syst.* **2018**, *12* (5), 1046–1055.
<https://doi.org/10.1109/TBCAS.2018.2845867>.